

**XPT™ 650V IGBT  
GenX3™ w/ Sonic  
Diode**
**IXYT30N65C3H1HV  
IXYH30N65C3H1**

 Extreme Light Punch Through  
IGBT for 20-60kHz Switching


$$V_{CES} = 650V$$

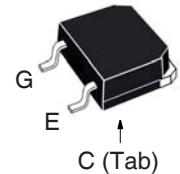
$$I_{C110} = 30A$$

$$V_{CE(sat)} \leq 2.7V$$

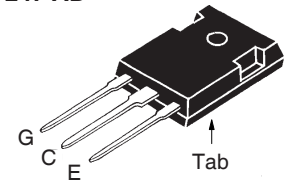
$$t_{fi(typ)} = 24ns$$

| Symbol                        | Test Conditions   | Maximum Ratings                        |            |
|-------------------------------|---|--|------------|
| $V_{CES}$                     | $T_J = 25^\circ C$ to $175^\circ C$   | 650                                    | V          |
| $V_{CGR}$                     | $T_J = 25^\circ C$ to $175^\circ C$ , $R_{GE} = 1M\Omega$                                   | 650                                    | V          |
| $V_{GES}$                     | Continuous  | $\pm 20$                               | V          |
| $V_{GEM}$                     | Transient   | $\pm 30$                               | V          |
| $I_{C25}$                     | $T_C = 25^\circ C$  | 60                                     | A          |
| $I_{C110}$                    | $T_C = 110^\circ C$   | 30                                     | A          |
| $I_{F110}$                    | $T_C = 110^\circ C$   | 29                                     | A          |
| $I_{CM}$                      | $T_C = 25^\circ C$ , 1ms  | 118                                    | A          |
| $I_A$                         | $T_C = 25^\circ C$  | 10                                     | A          |
| $E_{AS}$                      | $T_C = 25^\circ C$  | 300                                    | mJ         |
| <b>SSOA</b><br><b>(RBSOA)</b> | $V_{GE} = 15V$ , $T_{VJ} = 150^\circ C$ , $R_G = 10\Omega$<br>Clamped Inductive Load        | $I_{CM} = 60$<br>$V_{CE} \leq V_{CES}$ | A          |
| $t_{sc}$<br><b>(SCSOA)</b>    | $V_{GE} = 15V$ , $V_{CE} = 360V$ , $T_J = 150^\circ C$<br>$R_G = 82\Omega$ , Non Repetitive | 8                                      | $\mu s$    |
| $P_C$                         | $T_C = 25^\circ C$  | 270                                    | W          |
| $T_J$                         |   | -55 ... +175                           | $^\circ C$ |
| $T_{JM}$                      |   | 175                                    | $^\circ C$ |
| $T_{stg}$                     |   | -55 ... +175                           | $^\circ C$ |
| $T_L$                         | Maximum Lead Temperature for Soldering  | 300                                    | $^\circ C$ |
| $T_{SOLD}$                    | 1.6 mm (0.062in.) from Case for 10s   | 260                                    | $^\circ C$ |
| $M_d$                         | Mounting Torque   | 1.13/10                                | Nm/lb.in   |
| <b>Weight</b>                 | TO-220  | 4                                      | g          |
|                               | TO-247  | 6                                      | g          |

TO-268HV



TO-247 AD


 G = Gate                      C = Collector  
 E = Emitter                 Tab = Collector

**Features**

- Optimized for 20-60kHz Switching
- Square RBSOA
- High Voltage
- Avalanche Rated
- Short Circuit Capability
- Anti-Parallel Sonic Diode

**Advantages**

- High Power Density
- Extremely Rugged
- Low Gate Drive Requirement

**Applications**

- Power Inverters
- UPS
- Motor Drives
- SMPS
- PFC Circuits
- Battery Chargers
- Welding Machines
- Lamp Ballasts
- High Frequency Power Inverters

| Symbol        | Test Conditions<br>( $T_J = 25^\circ C$ , Unless Otherwise Specified) | Characteristic Values |      |                    |
|---------------|---|-----------------------|------|--------------------|
|               |   | Min.                  | Typ. | Max.               |
| $BV_{CES}$    | $I_C = 250\mu A$ , $V_{GE} = 0V$                                      | 650                   |      | V                  |
| $V_{GE(th)}$  | $I_C = 250\mu A$ , $V_{CE} = V_{GE}$                                  | 3.5                   |      | 6.0 V              |
| $I_{CES}$     | $V_{CE} = V_{CES}$ , $V_{GE} = 0V$<br>$T_J = 150^\circ C$             |                       |      | 50 $\mu A$<br>4 mA |
| $I_{GES}$     | $V_{CE} = 0V$ , $V_{GE} = \pm 20V$                                    |                       |      | $\pm 100$ nA       |
| $V_{CE(sat)}$ | $I_C = 30A$ , $V_{GE} = 15V$ , Note 1<br>$T_J = 150^\circ C$          | 2.35                  | 2.58 | V<br>V             |

| Symbol Test Conditions<br>( $T_J = 25^\circ\text{C}$ Unless Otherwise Specified) |  | Characteristic Values |      |                         |
|--|--|-----------------------|------|-------------------------|
|  |  | Min.                  | Typ. | Max.                    |
| $g_{fs}$   | $I_C = 30\text{A}, V_{CE} = 10\text{V}$ , Note 1   | 11                    | 19   | S                       |
| $C_{ies}$  | $V_{CE} = 25\text{V}, V_{GE} = 0\text{V}, f = 1\text{MHz}$   |                       | 1225 | pF                      |
| $C_{oes}$  |  |                       | 173  | pF                      |
| $C_{res}$  |  |                       | 28   | pF                      |
| $Q_{g(on)}$  | $I_C = 30\text{A}, V_{GE} = 15\text{V}, V_{CE} = 0.5 \cdot V_{CES}$  |                       | 44   | nC                      |
| $Q_{ge}$   |  |                       | 7    | nC                      |
| $Q_{gc}$   |  |                       | 24   | nC                      |
| $t_{d(on)}$  | <b>Inductive load, <math>T_J = 25^\circ\text{C}</math></b><br>$I_C = 30\text{A}, V_{GE} = 15\text{V}$<br>$V_{CE} = 400\text{V}, R_G = 10\Omega$<br>Note 2  |                       | 21   | ns                      |
| $t_{ri}$   |  |                       | 42   | ns                      |
| $E_{on}$   |  |                       | 1.00 | mJ                      |
| $t_{d(off)}$   |  |                       | 75   | ns                      |
| $t_{fi}$   |  |                       | 24   | ns                      |
| $E_{off}$  |  |                       | 0.27 | mJ                      |
| $t_{d(on)}$  | <b>Inductive load, <math>T_J = 150^\circ\text{C}</math></b><br>$I_C = 30\text{A}, V_{GE} = 15\text{V}$<br>$V_{CE} = 400\text{V}, R_G = 10\Omega$<br>Note 2 |                       | 19   | ns                      |
| $t_{ri}$   |  |                       | 40   | ns                      |
| $E_{on}$   |  |                       | 1.50 | mJ                      |
| $t_{d(off)}$   |  |                       | 90   | ns                      |
| $t_{fi}$   |  |                       | 30   | ns                      |
| $E_{off}$  |  |                       | 0.41 | mJ                      |
| $R_{thJC}$   | TO-247   |                       |      | 0.55 $^\circ\text{C/W}$ |
| $R_{thCS}$   |  |                       | 0.21 | $^\circ\text{C/W}$      |

**Reverse Sonic Diode (FRD)**

| Symbol Test Conditions<br>( $T_J = 25^\circ\text{C}$ Unless Otherwise Specified) |  | Characteristic Values     |      |                           |
|--|--|---------------------------|------|---------------------------|
|  |  | Min.                      | Typ. | Max.                      |
| $V_F$  | $I_F = 30\text{A}, V_{GE} = 0\text{V}$ , Note 1  | $T_J = 150^\circ\text{C}$ | 2.15 | 2.5 V                     |
|  |  |                           |      | V                         |
| $I_{RM}$   | $I_F = 30\text{A}, V_{GE} = 0\text{V},$<br>$-di_F/dt = 500\text{A}/\mu\text{s}, V_R = 400\text{V}$ | $T_J = 150^\circ\text{C}$ | 25   | A                         |
| $t_{rr}$   |  |                           |      | $T_J = 150^\circ\text{C}$ |
| $R_{thJC}$   |  |                           |      | 0.80 $^\circ\text{C/W}$   |

Notes:

1. Pulse test,  $t \leq 300\mu\text{s}$ , duty cycle,  $d \leq 2\%$ .
2. Switching times & energy losses may increase for higher  $V_{CE}$  (clamp),  $T_J$  or  $R_G$ .

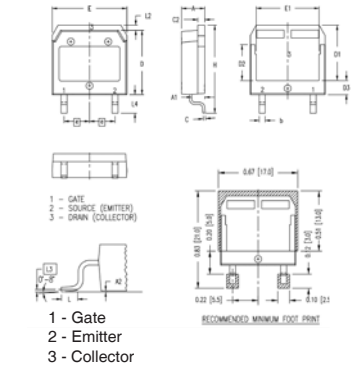
**PRELIMINARY TECHNICAL INFORMATION**

The product presented herein is under development. The Technical Specifications offered are derived from a subjective evaluation of the design, based upon prior knowledge and experience, and constitute a "considered reflection" of the anticipated result. IXYS reserves the right to change limits, test conditions, and dimensions without notice.

**IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.**

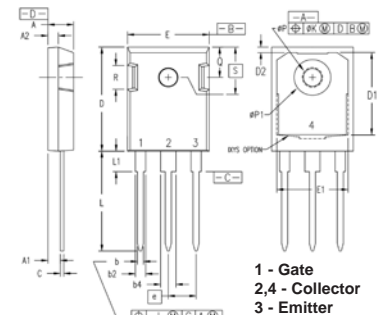
|  |           |           |           |           |              |              |              |              |              |             |
|--|-----------|-----------|-----------|-----------|--------------|--------------|--------------|--------------|--------------|-------------|
| IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents: | 4,835,592 | 4,931,844 | 5,049,961 | 5,237,481 | 6,162,665    | 6,404,065 B1 | 6,683,344    | 6,727,585    | 7,005,734 B2 | 7,157,338B2 |
|  | 4,860,072 | 5,017,508 | 5,063,307 | 5,381,025 | 6,259,123 B1 | 6,534,343    | 6,710,405 B2 | 6,759,692    | 7,063,975 B2 |             |
|  | 4,881,106 | 5,034,796 | 5,187,117 | 5,486,715 | 6,306,728 B1 | 6,583,505    | 6,710,463    | 6,771,478 B2 | 7,071,537    |             |

**TO-268HV Outline**



| Dim. | Millimeter |       | Inches    |       |
|------|------------|-------|-----------|-------|
|      | min        | max   | min       | max   |
| A    | 4.90       | 5.10  | 0.193     | 0.201 |
| A1   | 2.70       | 2.90  | 0.106     | 0.114 |
| A2   | 0.02       | 0.25  | 0.001     | 0.100 |
| b    | 1.15       | 1.45  | 0.045     | 0.057 |
| C    | 0.40       | 0.65  | 0.016     | 0.026 |
| C 2  | 1.45       | 1.60  | 0.057     | 0.063 |
| D    | 13.80      | 14.00 | 0.543     | 0.551 |
| D1   | 11.80      | 12.10 | 0.465     | 0.476 |
| D2   | 7.50       | 7.80  | 0.295     | 0.307 |
| D3   | 2.90       | 3.20  | 0.114     | 0.126 |
| E    | 15.85      | 16.05 | 0.624     | 0.632 |
| E1   | 13.30      | 13.60 | 0.524     | 0.535 |
| e    | 5.45 BSC   |       | 0.215 BSC |       |
| H    | 18.70      | 19.10 | 0.736     | 0.752 |
| L    | 1.70       | 2.00  | 0.067     | 0.079 |
| L2   | 1.00       | 1.15  | 0.039     | 0.045 |
| L3   | 0.25 BSC   |       | 0.010 BSC |       |
| L4   | 3.80       | 4.10  | 0.150     | 0.161 |

**TO-247 (IXYH) Outline**



| Dim. | Millimeter |       | Inches    |       |
|------|------------|-------|-----------|-------|
|      | min        | max   | min       | max   |
| A    | 4.70       | 5.30  | 0.185     | 0.209 |
| A1   | 2.21       | 2.59  | 0.087     | 0.102 |
| A2   | 1.50       | 2.49  | 0.059     | 0.098 |
| b    | 0.99       | 1.40  | 0.039     | 0.055 |
| b2   | 1.65       | 2.39  | 0.065     | 0.094 |
| b4   | 2.59       | 3.43  | 0.102     | 0.135 |
| c    | 0.38       | 0.89  | 0.015     | 0.035 |
| D    | 20.79      | 21.45 | 0.819     | 0.845 |
| D1   | 13.07      | -     | 0.515     | -     |
| D2   | 0.51       | 1.35  | 0.020     | 0.053 |
| E    | 15.48      | 16.24 | 0.610     | 0.640 |
| E1   | 13.45      | -     | 0.53      | -     |
| E2   | 4.31       | 5.48  | 0.170     | 0.216 |
| e    | 5.45 BSC   |       | 0.215 BSC |       |
| L    | 19.80      | 20.30 | 0.078     | 0.800 |
| L1   | -          | 4.49  | -         | 0.177 |
| Ø P  | 3.55       | 3.65  | 0.140     | 0.144 |
| Ø P1 | -          | 7.39  | -         | 0.290 |
| Q    | 5.38       | 6.19  | 0.212     | 0.244 |
| S    | 6.14 BSC   |       | 0.242 BSC |       |

Fig. 1. Output Characteristics @  $T_J = 25^\circ\text{C}$

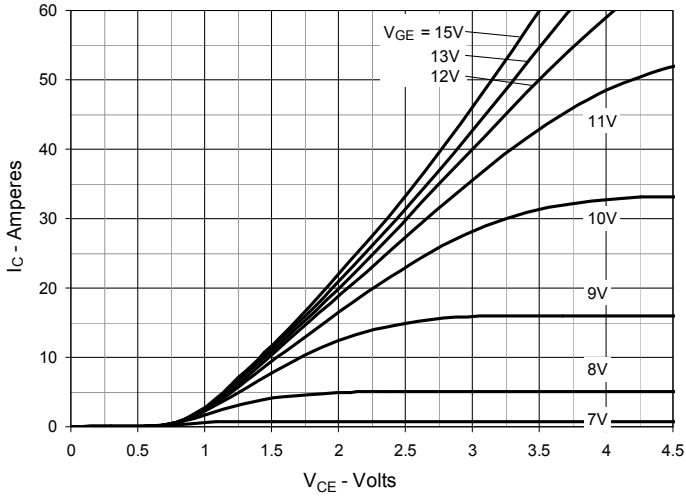


Fig. 2. Extended Output Characteristics @  $T_J = 25^\circ\text{C}$

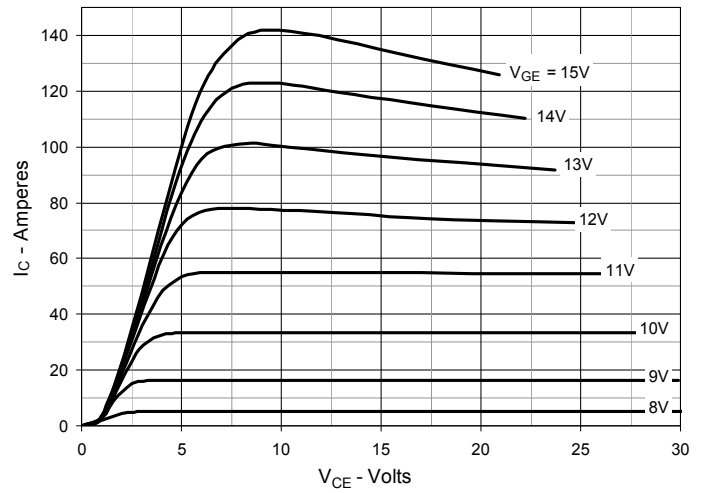


Fig. 3. Output Characteristics @  $T_J = 150^\circ\text{C}$

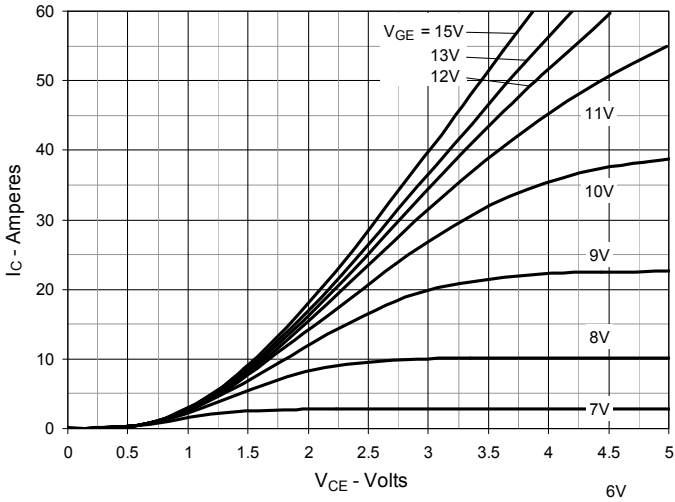


Fig. 4. Dependence of  $V_{CE(sat)}$  on Junction Temperature

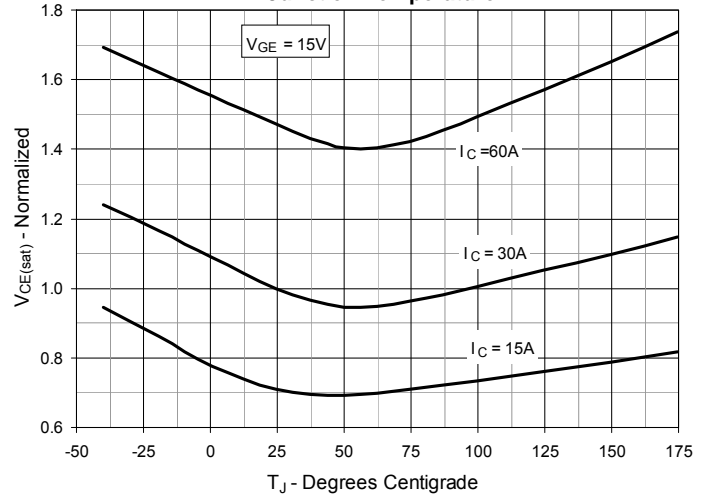


Fig. 5. Collector-to-Emitter Voltage vs. Gate-to-Emitter Voltage

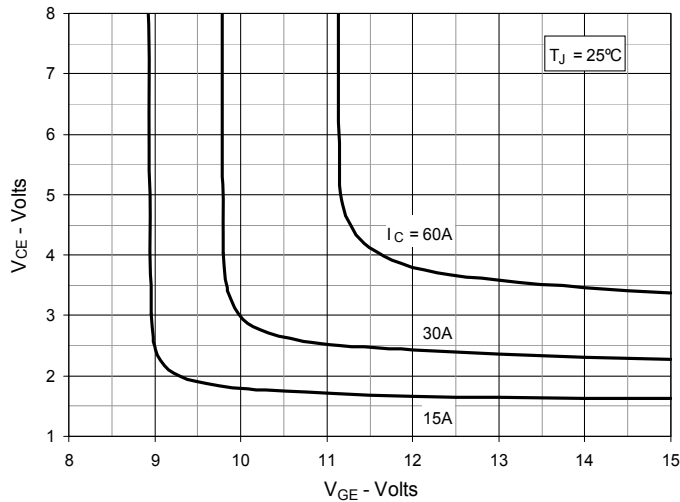


Fig. 6. Input Admittance

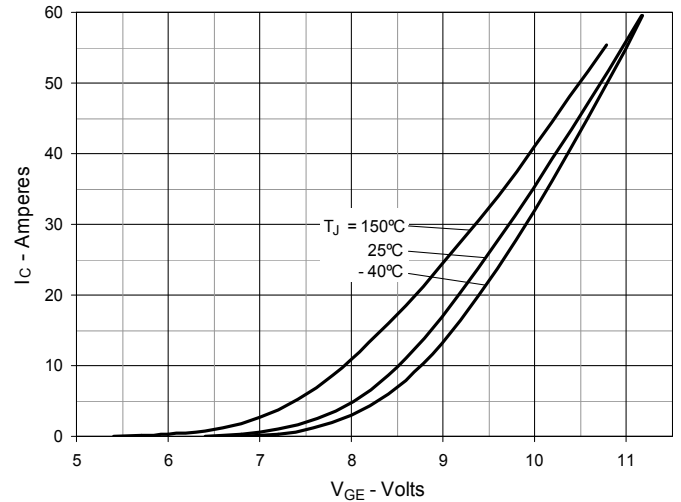


Fig. 7. Transconductance

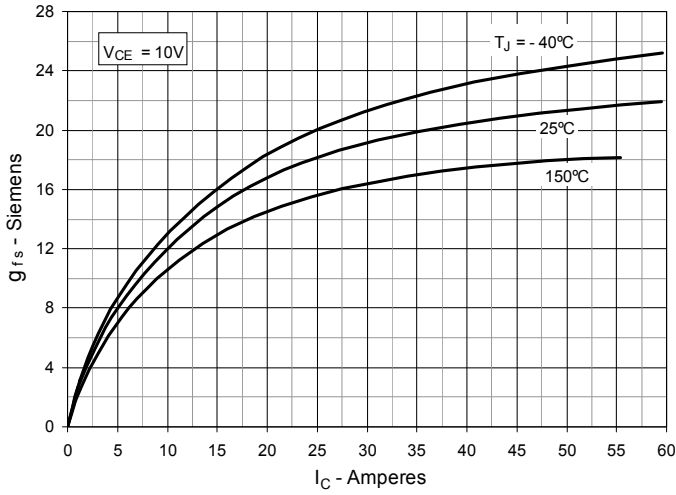


Fig. 8. Gate Charge

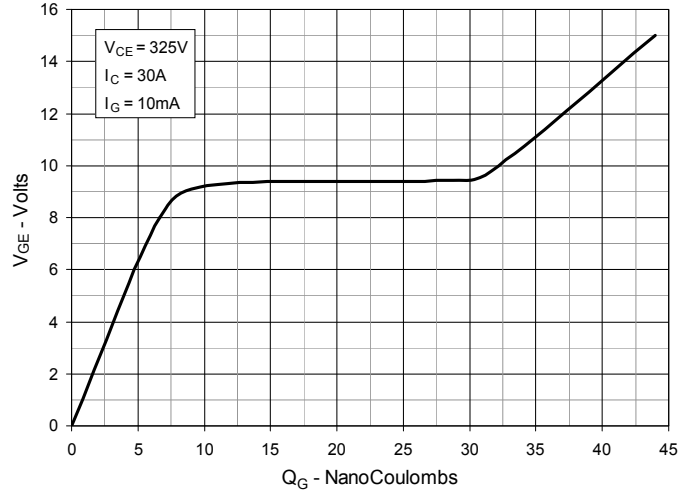


Fig. 9. Capacitance

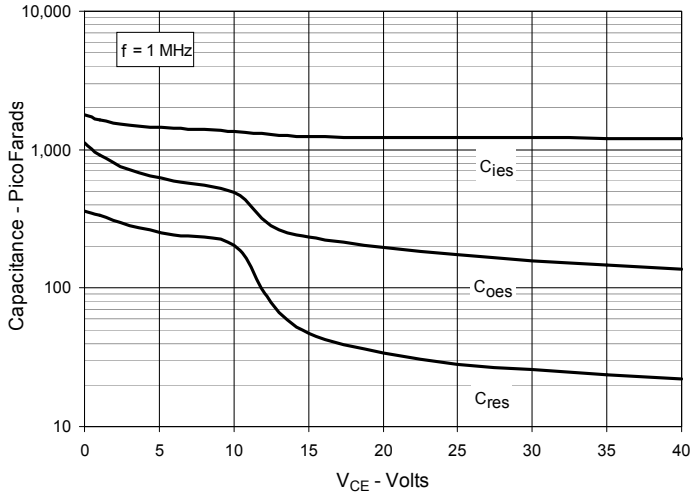


Fig. 10. Reverse-Bias Safe Operating Area

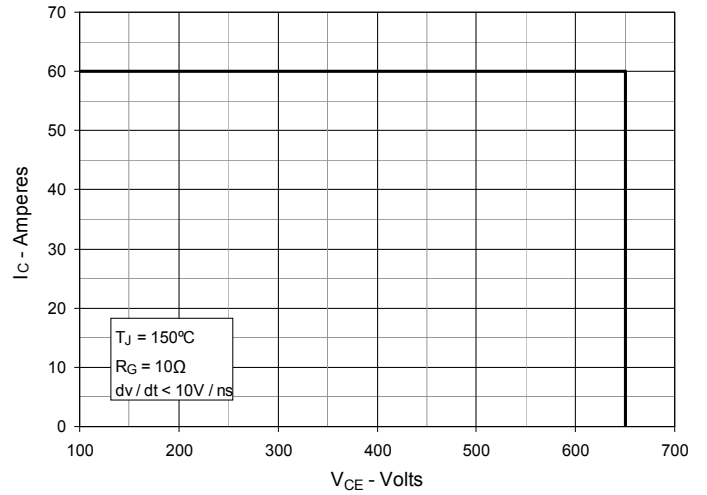
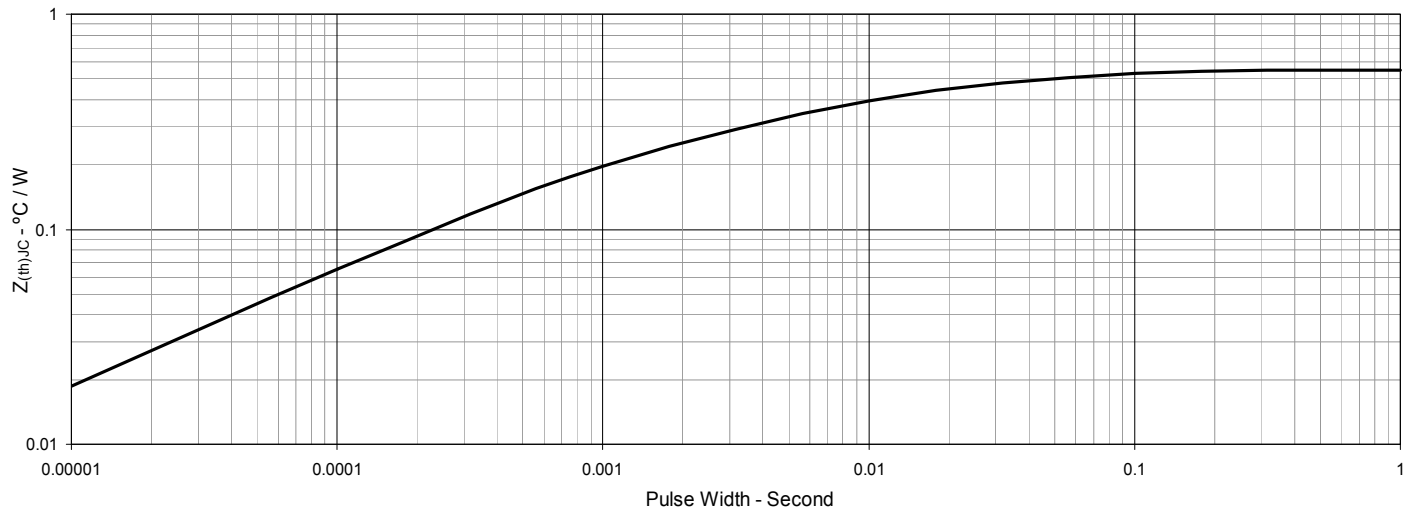


Fig. 11. Maximum Transient Thermal Impedance



**Fig. 12. Inductive Switching Energy Loss vs. Gate Resistance**



**Fig. 13. Inductive Switching Energy Loss vs. Collector Current**



**Fig. 14. Inductive Switching Energy Loss vs. Junction Temperature**



**Fig. 15. Inductive Turn-off Switching Times vs. Gate Resistance**



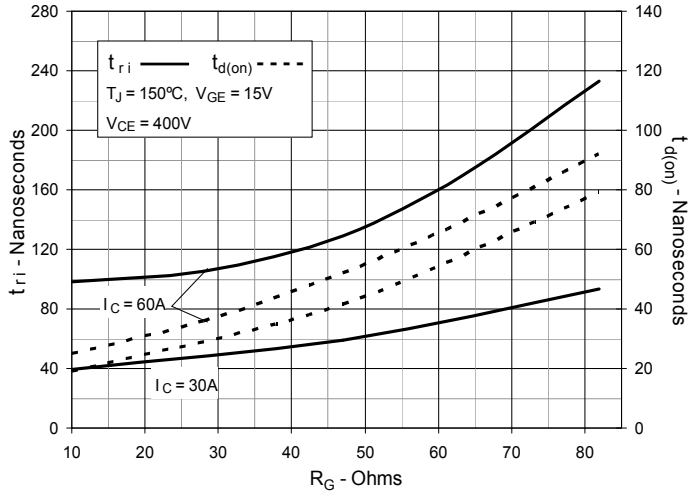
**Fig. 16. Inductive Turn-off Switching Times vs. Collector Current**



**Fig. 17. Inductive Turn-off Switching Times vs. Junction Temperature**



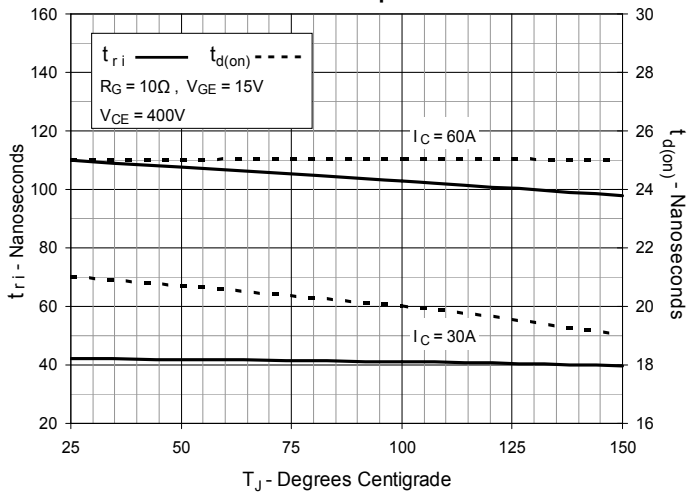
**Fig. 18. Inductive Turn-on Switching Times vs. Gate Resistance**



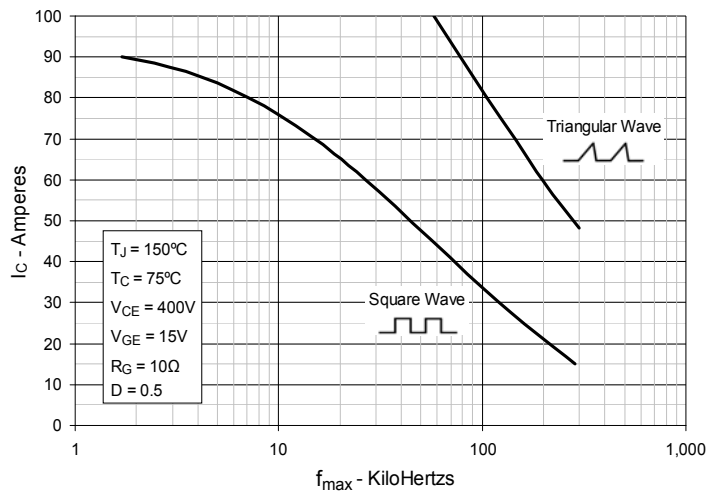
**Fig. 19. Inductive Turn-on Switching Times vs. Collector Current**



**Fig. 20. Inductive Turn-on Switching Times vs. Junction Temperature**



**Fig. 21. Maximum Peak Load Current vs. Frequency**





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